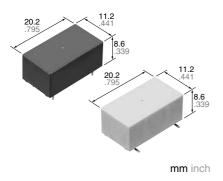
Panasonic

2.6 GHz capable, 10 W carrying power (at 2.6 GHz), $50\Omega/75\Omega$ impedance and 1 Form C relays

RE RELAYS (ARE)



FEATURES

- Excellent high frequency characteristics (to 2.6GHz)
- Surface-mount type also available
- Compact and slim size Size: $20.2(L) \times 11.2(W) \times 8.9(H)^*$ mm $.795(L) \times .441(W) \times .350(H)$ inch
- *The height of Surface-mount type is 9.6 mm .378 inch size.

TYPICAL APPLICATIONS

- 1. Broadcasting and video markets.
 - Digital broadcasting equipment
 - STB/tuner

2. Communications market

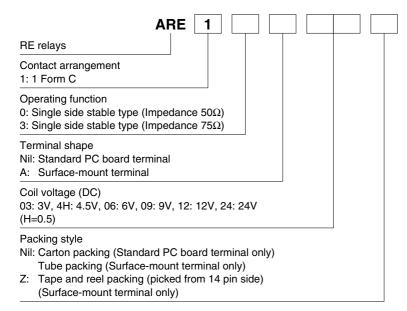
- Antennae switching
- · All types of wireless devices

If you consider using applications with low level loads or with high frequency switching, please consult us.

RoHS compliant

Protective construction: Sealed type

ORDERING INFORMATION



-1-

TYPES

1. Standard PC board terminal

| Datad valtage | Part No. | | | Standard packing | |
|---------------|---|--|---------|------------------|--|
| Rated voltage | Single side stable type (Impedance 50Ω) | Single side stable type (Impedance 75 Ω) | Carton | Case | |
| 3 V DC | ARE1003 ARE1303 | | | | |
| 4.5 V DC | ARE104H | ARE134H | | | |
| 6 V DC | ARE1006 | ARE1306 | F0 mag | 500 pcs. | |
| 9 V DC | ARE1009 | ARE1309 | 50 pcs. | 500 pcs. | |
| 12 V DC | ARE1012 ARE1312 | | | | |
| 24 V DC | ARE1024 | ARE1324 | | | |

2. Surface-mount terminal

1) Tube package

| Potod voltage | Part No. | | | Standard packing | |
|-------------------|---|----------|---------|------------------|--|
| Rated voltage | Single side stable type (Impedance 50Ω) Single side stable type (Impedance 75Ω) | | Tube | Case | |
| 3 V DC | ARE10A03 ARE13A03 | | | | |
| 4.5 V DC ARE10A4H | | ARE13A4H | | | |
| 6 V DC | ARE10A06 | ARE13A06 | 25 pag | 200 200 | |
| 9 V DC | ARE10A09 | ARE13A09 | 25 pcs. | 200 pcs. | |
| 12 V DC | ARE10A12 ARE13A12 | | | | |
| 24 V DC | ARE10A24 | ARE13A24 | | | |

2) Tape and reel package

| Datad valtage | Part No. | | | Standard packing | |
|---------------|---|-----------|---------------|------------------|--|
| Rated voltage | Single side stable type (Impedance 50Ω) Single side stable type (Impedance 75Ω) | | Tape and reel | Case | |
| 3 V DC | ARE10A03Z | ARE13A03Z | | | |
| 4.5 V DC | ARE10A4HZ | ARE13A4HZ | | | |
| 6 V DC | ARE10A06Z | ARE13A06Z | 400 pcs. | 900 pag | |
| 9 V DC | ARE10A09Z | ARE13A09Z | 400 pcs. | 800 pcs | |
| 12 V DC | ARE10A12Z | ARE13A12Z | | | |
| 24 V DC | ARE10A24Z | ARE13A24Z | | | |

RATING

1. Coil data

| Rated voltage | Pick-up voltage* (at 20°C 68°F) | Drop-out voltage* (at 20°C 68°F) | Rated operating current [±10%] (at 20°C 68°F) | Coil resistance [±10%] (at 20°C 68°F) | Rated operating power | Max. allowable voltage | | |
|---------------|---|-------------------------------------|---|--|-----------------------|------------------------|--|-----------------------|
| 3 V DC | | | 66.7 mA | 45 Ω | | | | |
| 4.5 V DC | | | 44.4 mA | 101 Ω | | | | |
| 6 V DC | 75%V or less of rated voltage (Initial) (Initial) | | rated voltage | | 33.3 mA | 180 Ω | 200 mW | 110%V (at 60°C 140°F) |
| 9 V DC | | | | 22.2 mA | 405 Ω | 200 11100 | 150%V (at 20°C 68°F) of rated voltage | |
| 12 V DC | | 16.7 mA | 720 Ω | | or ration romago | | | |
| 24 V DC | | | 8.3 mA | 2,880 Ω | | | | |

^{*} Square, pulse drive (JIS C5442)

2. Specifications

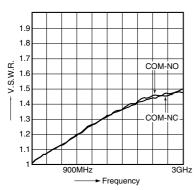
| Characteristics | Item | | Specifications | | |
|--------------------------------|--|-------------|---|--|--|
| | Arrangement | | 1 Form C | | |
| | Contact resistance (initial) | | Max. 100mΩ (By voltage drop 10V AC 10mA) | | |
| | Contact mate | erial | Gold plating | | |
| Contact data | Contact rating (resistive) | | 1W (at 2.6 GHz [Impedance 50Ω, V.S.W.R. Max.1.7] [Impedance 75Ω;, V.S.W.R. Max.1.5]) 10mA 24V DC | | |
| | Contact inpu | t power | 10W (at 2.6GHz [Impedance 50Ω, V.S.W.R. Max.1.7] [Impedance 75Ω, V.S.W.R. Max.1.5]) | | |
| | Max. switching | ng voltage | 30V DC | | |
| | Max. switching | ng current | 0.5A DC | | |
| High frequency | V.S.W.R. | | Max. 1.3 (to 900MHz), Max. 1.7 (to 2.6GHz) | | |
| characteristics (Initial) | Insertion loss | S | Max. 0.2dB (to 900MHz), Max. 0.7dB (to 2.6GHz) | | |
| (Impedance 50Ω) | Isolation | | Min. 60dB (to 900MHz), Min. 30dB (to 2.6GHz) | | |
| High frequency | V.S.W.R. | | Max. 1.2 (to 900MHz), Max. 1.5 (to 2.6GHz) | | |
| characteristics (Initial) | Insertion loss | S | Max. 0.2dB (to 900MHz), Max. 0.5dB (to 2.6GHz) | | |
| (Impedance 75Ω) | Isolation | | Min. 60dB (to 900MHz), Min. 30dB (to 2.6GHz) | | |
| nsulation resistance (I | nsulation resistance (Initial) | | Min. 100M Ω (at 500V DC, Measured portion is the same as the case of dielectric voltage.) | | |
| D | Between open contacts | | 500 Vrms for 1min. (detection current: 10mA) | | |
| Breakdown voltage (Initial) | Between contact and coil | | 1,000 Vrms for 1min. (detection current: 10mA) | | |
| ,ππααι) | Between contact and earth terminal | | 500 Vrms for 1min. (detection current: 10mA) | | |
| Time characteristics | Operate time (initial) | | Max. 10ms (at 20°C 68°F, at rated voltage, without bounce) | | |
| Time characteristics | Release time (initial) | | Max. 5ms (at 20°C 68°F, at rated voltage, without bounce, without diode) | | |
| | Shock | Functional | Min. 500 m/s² (half-sine shock pulse: 11ms; detection time: 10μs) | | |
| Mechanical | resistance | Destructive | Min. 1,000m/s ² (half-sine shock pulse: 6ms) | | |
| characteristics | Vibration | Functional | 10 to 55 Hz at double amplitude of 3mm (detection time: 10μs) | | |
| | resistance | Destructive | 10 to 55 Hz at double amplitude of 5mm | | |
| | Mechanical | | Min. 10 ⁶ (at 180 times/min.) | | |
| Expected life | Electrical | | Min. 3×10^5 (1W, 2.6GHz, [Impedance 50Ω , V.S.W.R. \leq 1.7] [Impedance 75Ω , V.S.W.R. \leq 1.5] Min. 3×10^5 (10mA 24V DC (resistive) (at 20 times/min.)) | | |
| Conditions | Conditions for operation, transport and storage* | | Ambient temperature: -40 to +70°C -40 to +158°F Humidity: 5 to 85% R.H. (Not freezing and condensing at low temperature) | | |
| Unit weight | | | Approx. 5 g .18 oz | | |

Note: * The upper operation ambient temperature limit is the maximum temperature that can satisfy the coil temperature rise value. Refer to [6] AMBIENT ENVIRONMENT in GENERAL APPLICATION GUIDELINES.

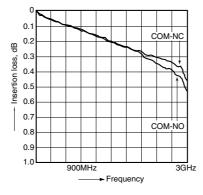
REFERENCE DATA

1-(1). High frequency characteristics (Impedance 50Ω) (Standard PC board terminal)

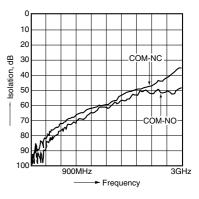
• V.S.W.R. characteristics



• Insertion loss characteristics

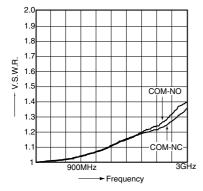


• Isolation characteristics

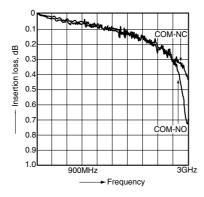


1-(2). High frequency characteristics (Impedance 75Ω) (Standard PC board terminal)

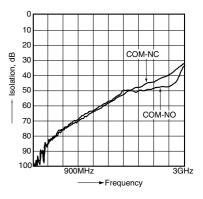




• Insertion loss characteristics



• Isolation characteristics



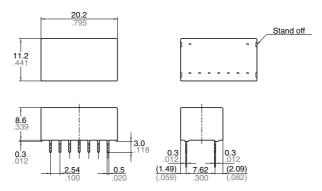
DIMENSIONS (mm inch)

The CAD data of the products with a CAD mark can be downloaded from: http://industrial.panasonic.com/ac/e/

1. Standard PC board terminal (50 Ω , 75 Ω type)

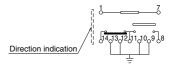






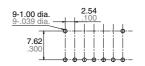
Tolerance: $\pm 0.3 \pm .012$

Schematic (Bottom view)



(Deenergized condition)

PC board pattern



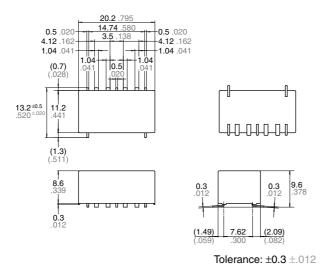
Tolerance: ±0.1 ±.004

2. Surface mount terminal

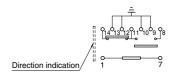
• 50 Ω type

CAD



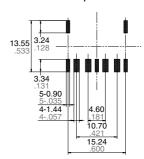


Schematic (Top view)



(Deenergized condition)

PC board pattern

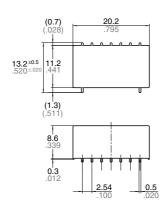


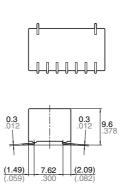
Tolerance: ±0.1 ±.004

• 75 Ω type



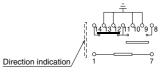






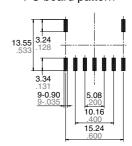
Tolerance: $\pm 0.3 \pm .012$

Schematic (Top view)



(Deenergized condition)

PC board pattern



Tolerance: $\pm 0.1 \pm .004$

NOTES

1. Coil operating power

Pure DC current should be applied to the coil. The wave form should be rectangular. If it includes ripple, the ripple factor should be less than 5%.

However, check it with the actual circuit since the characteristics may be slightly different.

2. Cleaning

For automatic cleaning, the boiling method is recommended. Avoid ultrasonic cleaning which subjects the relays to high frequency vibrations, which may cause the contacts to stick. It is recommended that alcoholic solvents be used.

3. Soldering

(Standard PC board terminal)

1) The manual soldering shall be performed under following condition.

Max. 260°C 500°F 10s Max. 350°C 662°F 3s

The affect of the PCB on the relay will differ depending on the type of PCB used. Please verify the type of PCB to be used. Preheat according to the following conditions.

| Temperature | 120°C 248°F or less |
|-------------|---------------------|
| Time | Within 2 minute |

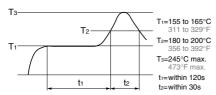
Soldering should be done at 260±5°C 500±9°F within 6 s. 2) In case of automatic soldering, the following conditions should be observed (Surface-mount terminal)

(1) Position of measuring temperature



A: Surface of PC board where relay is mounted

(2) IR (infrared reflow) soldering method

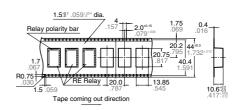


Temperature rise of relay itself may vary according to the mounting level or the heating method of reflow equipment. Therefore, please set the temperature of soldering portion of relay terminal and the top surface of the relay case not to exceed the above mentioned soldering condition.

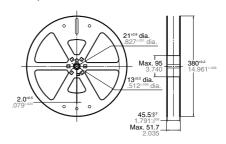
It is recommended to check the temperature rise of each portion under actual mounting condition before use.

4. Packing style

1) Tape dimensions



2) Dimensions of plastic reel



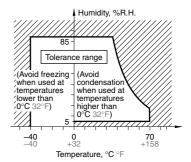
5. Conditions for operation, transport and storage conditions

- 1) Ambient temperature, humidity, and atmospheric pressure during usage, transport, and storage of the relay:
- (1) Temperature:
- -40 to +70°C -40 to +158°F
- (2) Humidity: 5 to 85% RH

(Avoid freezing and condensation.)

The humidity range varies with the temperature. Use within the range indicated in the graph below.

(3) Atmospheric pressure: 86 to 106 kPa Temperature and humidity range for usage, transport, and storage:



2) Condensation

Condensation forms when there is a sudden change in temperature under high temperature and high humidity conditions. Condensation will cause deterioration of the relay insulation.

3) Freezing

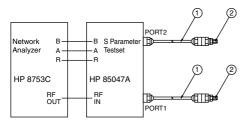
Condensation or other moisture may freeze on the relay when the temperature is lower than 0°C 32°F. This causes problems such as sticking of movable parts or operational time lags.

4) Low temperature, low humidity environments

The plastic becomes brittle if the relay is exposed to a low temperature, low humidity environment for long periods of time.

6. Measuring method

1) 50Ω type

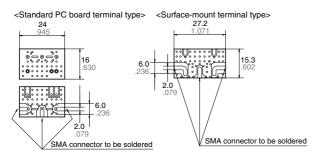


Connect connectors 1 and 2 respectively to PORT1 and PORT2. Perform calibration using the 3.5 mm .138 inch calibration kit (50 Ω).

| No. | Part number | Description | | |
|-----|-------------|---|--|--|
| 1 | HP 11857D | 7mm .276inch Test port, Extension cable. (APC7 connector) | | |
| 2 | HP 11533A | Adapter APC7-SMA (Male) | | |

After calibration, connect the D.U.T board and measure.

D.U.T board Dimension (mm inch)



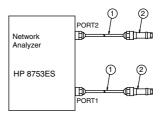
Material: Glass PTFE (Double sided, Through hole) R-4737 (Panasonic Corporation)

Thickness: t = 0.8 mm .031inch Copper thickness: $18\mu m$

Connector (SMA)

Product name: R125 510 (RADIALL)

2) 75Ω type

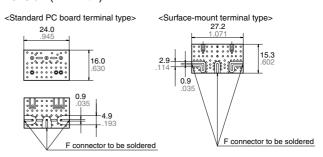


Connect connectors 1 and 2 respectively to PORT1 and PORT2. Perform calibration using the 3.5 mm .138 inch calibration kit (70Ω) .

| No. | Part number | Description | |
|-----|-------------|-------------------------------------|--|
| 1 | HP 11857B | 75ΩF Test port, Return cable | |
| 2 | 85039-60011 | Adapter 75ΩN (Female) – 75ΩF (Male) | |

After calibration, connect the D.U.T board and measure.

D.U.T board Dimension (mm inch)



Material: Glass PTFE (Double sided, Through hole) R-4737 (Panasonic Corporation)

Thickness: t = 0.8 mm .031inch Copper thickness: $18 \mu m$

Connector (F)

Product name: C05-0236 (KOMINE MUSEN DENKI)

For general cautions for use, please refer to the "General Application Guidelines".

Panasonic Corporation
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ASCTB104E 201703-T

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